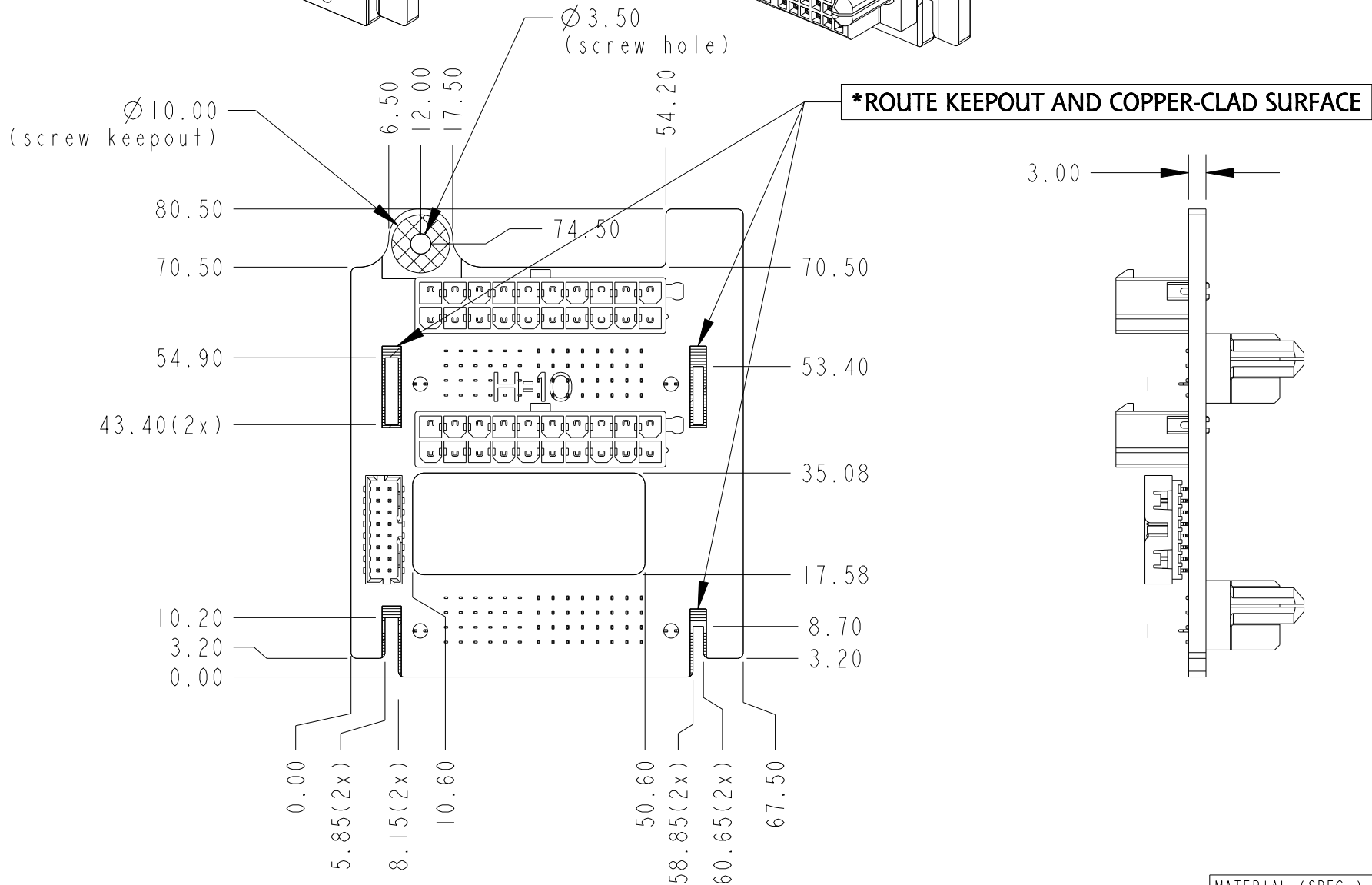


MYLAR ASSEMBLY REFERS TO NEXT PAGE

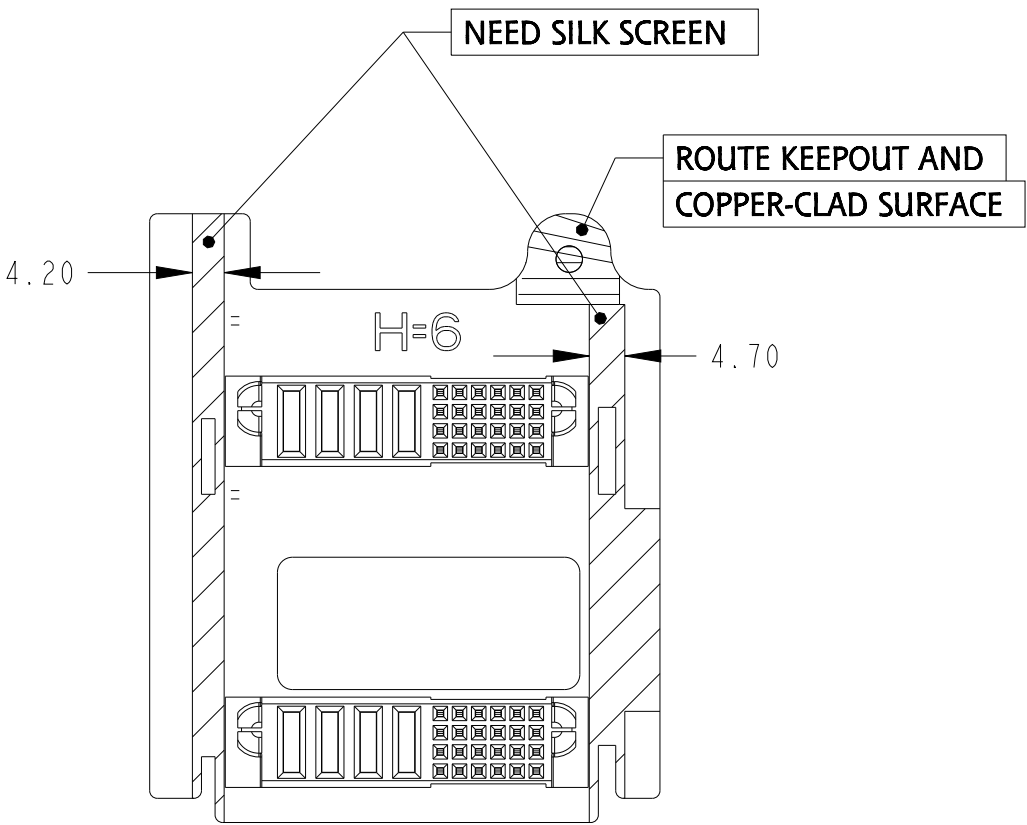
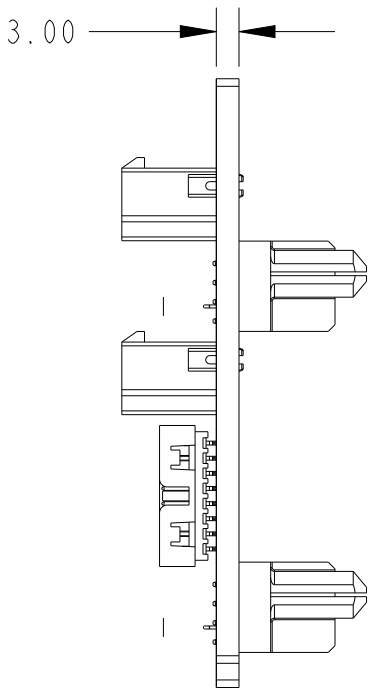
VER.	MARK.	DCR/ECN NO.	DATE	UPDARE DESCRIPTION	SIGNATURE.
00			Dec-23-19	First Release	Wayne Yang

- NOTE:
- 1. PCB THICKNESS = 3.00mm
 - 2.  ROUTE KEEPOUT & Copper pad.
 - 2.  ROUTE KEEPOUT & H=0
 - 3.  H=0



TOP SIDE

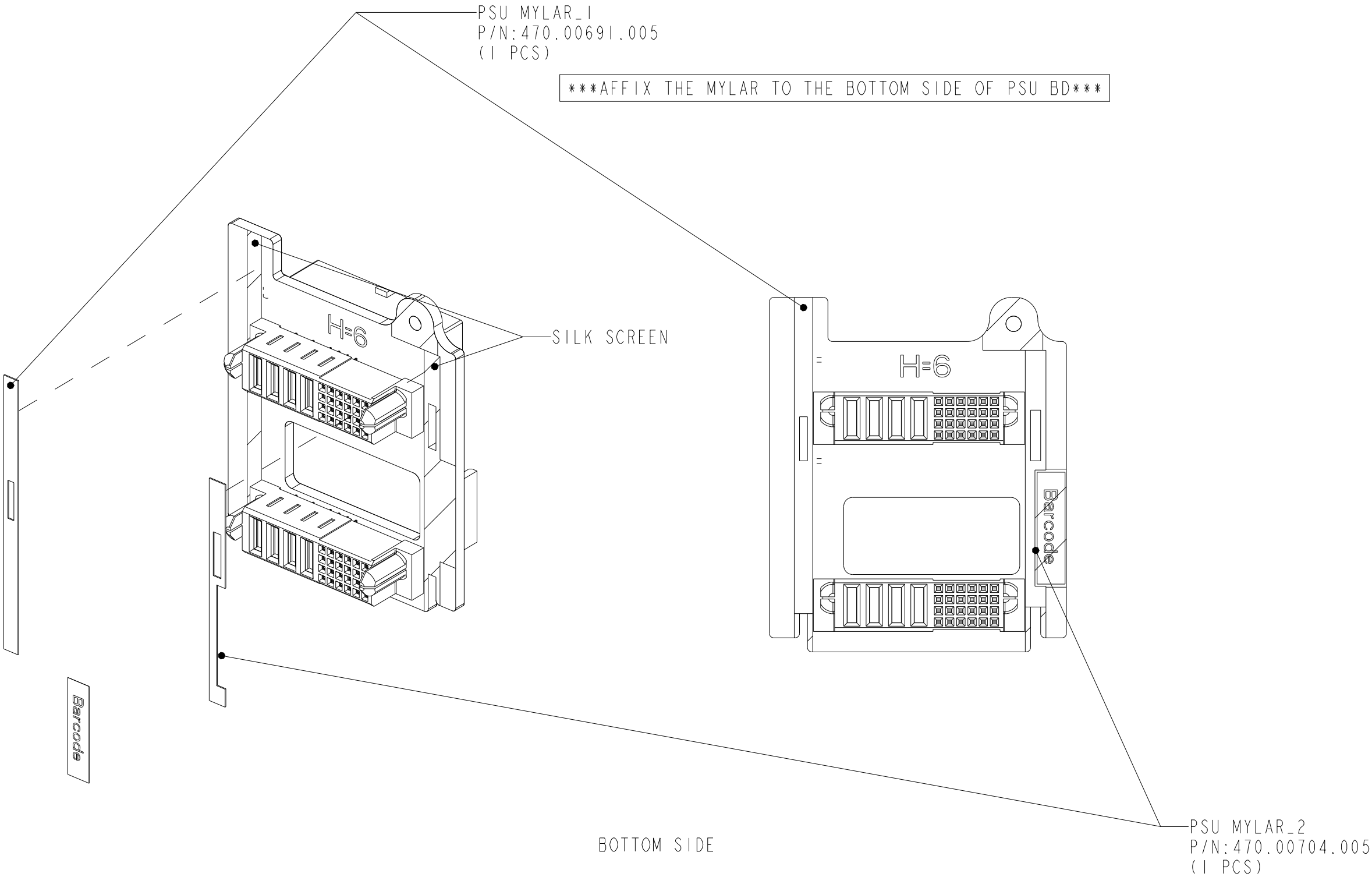
PCB THICKNESS = 3.00mm +/- 10%



BOTTOM SIDE

MATERIAL (SPEC.)										SCALE				
SEE NOTE										1.000				
FINISH										SHEET				
SEE NOTE										1/2				
Select Dim.	Tol.	A	B	C	EPS	EPE	BAG	CTN	LABEL	USR	UNIT	PART NAME		
0~6	0.05	0.05	0.10							0.20	mm	03_POWER_PCB_ASM_100G_E/C_R		
6~30	0.10	0.15	0.20	0.50	0.50	3.00				0.20		MODEL	PART NO.	DESIGNED
30~120	0.15	0.20	0.30	0.50	0.50	5.00	2.00	0.25	0.10					Wayne Yang
120~300	0.20	0.30	0.40	1.00	1.00	10.00	3.00	0.30	0.15					
300~450	0.25	0.40	0.50	2.00	2.00	15.00	5.00	0.50	0.20					
450~600	0.30	0.50	0.60	3.00	3.00	20.00	5.00	0.80	0.20					
DRAFT TOLERANCE ±0.2°										CRITICAL DIM. MARK *				

VER.	MARK.	DCR/ECN NO.	DATE	UPDARE DESCRIPTION	SIGNATURE.
00			Dec-23-19	First Release	Wayne Yang



MATERIAL (SPEC.)		SEE NOTE		SCALE				
FINISH		SEE NOTE		SHEET				
UNIT		mm		2/2	PART NAME			
SIZE		A3			03_POWER_PCB_ASM_100G_E/C_R			
CUSTOMER MODEL		100G E/C R			MODEL		PART NO.	DESIGNED
CUSTOMER PART NO.		N/A						Wayne Yang
APPROVED		Jason Huang						